

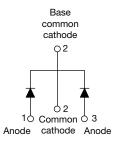
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Vishay Semiconductors

HEXFRED®, Ultrafast Soft Recovery Diode, 2 x 4 A



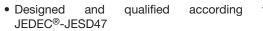
TO-220AB



PRODUCT SUMMARY				
Package	TO-220AB			
I _{F(AV)}	2 x 4 A			
V _R	600 V			
V _F at I _F	1.8 V			
t _{rr} typ.	17 ns			
T _J max.	150 °C			
Diode variation	Common cathode			

FEATURES

- · Ultrafast and ultrasoft recovery
- Very low I_{RRM} and Q_{rr}





 Material categorization: for definitions of compliance please see www.vishay.com/doc?99912







BENEFITS

- Reduced RFI and EMI
- Reduced power loss in diode and switching transistor
- · Higher frequency operation
- · Reduced snubbing
- Reduced parts count

DESCRIPTION

VS-HFA08TA60C... is a state of the art center tap ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 V and 4 A per leg continuous current, the VS-HFA08TA60C... is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA08TA60C... is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V_R		600	V	
Maximum continuous forward current per leg	- I _F	T _C = 100 °C	4		
per device			8	Α	
Single pulse forward current			25	A	
Maximum repetitive forward current			16		
Maximum power dissipation	P _D	T _C = 25 °C	25	W	
waximum power dissipation		T _C = 100 °C	10	VV	
Operating junction and storage temperature range	T _J , T _{Stg}		-55 to +150	°C	



VS-HFA08TA60CPbF, VS-HFA08TA60C-N3

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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V_{BR}	Ι _R = 100 μΑ		600	-	-	
Maximum forward voltage		I _F = 4.0 A	See fig. 1	-	1.5	1.8	V
	V_{FM}	I _F = 8.0 A		-	1.8	2.2	
		I _F = 4.0 A, T _J = 125 °C		-	1.4	1.7	
Maximum reverse		V _R = V _R rated	Coo fig. 0	-	0.17	3.0	
leakage current	I _{RM}	$T_J = 125 ^{\circ}\text{C}, V_R = 0.8 \text{x} V_R \text{rated}$	See fig. 2	-	44	300	μΑ
Junction capacitance	C _T	V _R = 200 V	See fig. 3	-	4.0	8.0	pF
Series inductance	L _S	Measured lead to lead 5 mm from package body		-	8.0	-	nH

DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
	t _{rr}	$I_F = 1.0 \text{ A}, dI_F/dt = 200 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$		-	17	-	
Reverse recovery time See fig. 5, 6 and 16	t _{rr1}	T _J = 25 °C	I _F = 4.0 A dI _F /dt = 200 A/μs V _R = 200 V	-	28	42	ns
	t _{rr2}	T _J = 125 °C		-	38	57	
Peak recovery current See fig. 7 and 8	I _{RRM1}	T _J = 25 °C		-	2.9	5.2	A nC
	I _{RRM2}	T _J = 125 °C		-	3.7	6.7	
Reverse recovery charge See fig. 9 and 10	Q _{rr1}	T _J = 25 °C		-	40	60	
	Q _{rr2}	T _J = 125 °C		-	70	105	IIC
Peak rate of fall of recovery current during t _b See fig. 11 and 12	dI _{(rec)M} /dt1	T _J = 25 °C		-	280	-	- A/µs
	dI _{(rec)M} /dt2	T _J = 125 °C		-	235	-	Ανμδ

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Lead temperature	T _{lead}	0.063" from case (1.6 mm) for 10 s	-	-	300	°C
Thermal resistance, junction to case	R _{thJC}		-	-	5.0	
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	80	K/W
Thermal resistance, case to heatsink	R _{thCS}	Mounting surface, flat, smooth and greased	-	0.5	-	
Woight			-	2.0	-	g
Weight			-	0.07	-	OZ.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)
Marking device		Case style TO-220AB		HFA08	TA60C	



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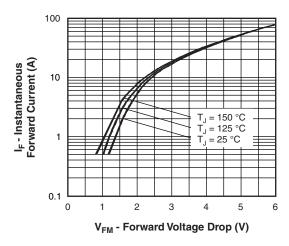


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

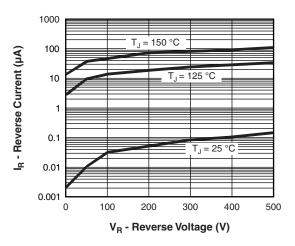


Fig. 2 - Typical Reverse Current vs. Reverse Voltage

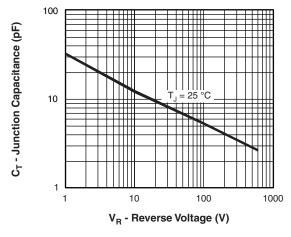


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

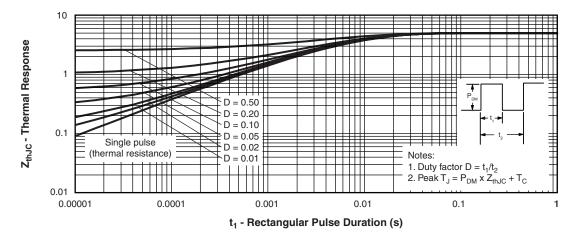


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

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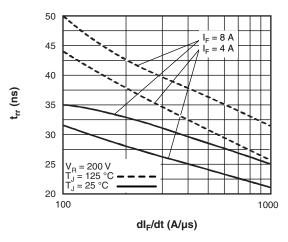


Fig. 5 - Typical Reverse Recovery Time vs. dl_E/dt

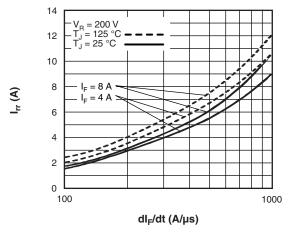


Fig. 6 - Typical Recovery Current vs. dI_F/dt

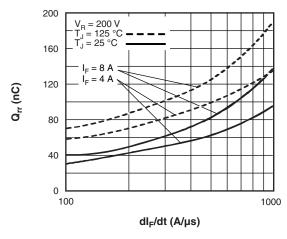


Fig. 7 - Typical Stored Charge vs. dl_F/dt

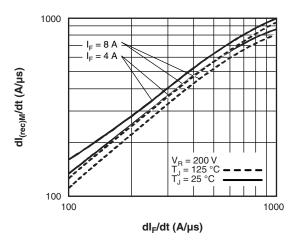
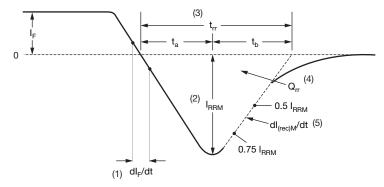


Fig. 8 - Typical dI_{(rec)M}/dt vs. dI_F/dt



- (1) dl_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) $\rm t_{rr}$ reverse recovery time measured from zero crossing point of negative going $\rm I_F$ to point where a line passing through 0.75 $\rm I_{RRM}$ and 0.50 $\rm I_{RRM}$ extrapolated to zero current.
- (4) $\mathbf{Q}_{\rm rr}$ area under curve defined by $\mathbf{t}_{\rm rr}$ and $\mathbf{I}_{\rm RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

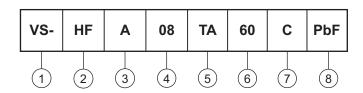
Fig. 9 - Reverse Recovery Waveform and Definitions

VS-HFA08TA60CPbF, VS-HFA08TA60C-N3

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ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - HEXFRED® family

Electron irradiated

- Current rating (08 = 8 A)

5 - Package:

TA = TO-220AB

6 - Voltage rating (60 = 600 V)

7 - Circuit configuration:

C = common cathode

7 - Environmental digit:

PbF = lead (Pb)-free and RoHS-compliant

-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)					
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION		
VS-HFA08TA60CPbF	50	1000	Antistatic plastic tube		
VS-HFA08TA60C-N3	50	1000	Antistatic plastic tube		

LINKS TO RELATED DOCUMENTS				
Dimensions		www.vishay.com/doc?95222		
Part marking information	TO-220ABPbF	www.vishay.com/doc?95225		
Fait marking information	TO-220AB-N3	www.vishay.com/doc?95028		



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